506063282 05/18/2020

# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
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Yun-Chih Chang	05/14/2020

### **RECEIVING PARTY DATA**

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## **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16876151

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NAME OF SUBMITTER:	KATE YEH
SIGNATURE:	/KATE YEH/
DATE SIGNED:	05/18/2020

### **Total Attachments: 4**

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> **PATENT** REEL: 052681 FRAME: 0266

506063282

# COMBINE DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT

## Title of Invention:

# METHOD AND APPARATUS FOR PERFORMING POWER MESH OPTIMIZATION WITH AID OF ADDITIONAL WIRES

As the below named inventor, I hereby declare that: This declaration is directed to:		
☑ The attached application, or		
☐ United States application number	filed on	, or
☐ PCT international application number	filed on	
The above-identified application was made or authorized	o be made by me.	
I believe that I am the original inventor or an original joint i application.	nventor of a claimed invention in	the
I hereby acknowledge that any willful false statement mad under18 U.S.C. 1001 by fine or imprisonment of not more	e in this declaration is punishable than five (5) years, or both.	•
In consideration of the payment by Realtek Semicon	ductor Corp. having a po	stal address of
2 Innovation Rd. II, Science Park, HsinChu 300	76, Taiwan, R.O.C.	
(referred to as "ASSIGNEE" below) to I of the sum of One acknowledged, andfor other good and valuable considerate	Dollar (\$ 1.00), the receipt of whi	ch is hereby
I hereby sell, assign and transfer to ASSIGNEE and the set the entire right, title and interest in and to any and all impri invention as above-identified application and, in and to, all invention by the above application or any continuations, co substitutes, or extensions thereof, and as to Letters Paten	ovements which are disclosed in Letters Patent to be obtained for ontinuation-in-part, divisions, rene	the r said ewals,
I hereby covenant that no assignment, sale, agreement or entered into which would conflict with this assignment;	encumbrance has been or will b	e made or
I further covenant that ASSIGNEE will, upon its request, b and documents relating to said invention and said Letters known and accessible to I and will testify as to the same ir related thereto and will promptly execute and deliver to AS	Patent and legal equivalents as r any interference, litigation proce	nay be
representatives any and all papers, instruments or affidavi maintain, issue and enforce said application, said invention equivalents thereof which may be necessary or desirable to IN WITNESS WHEREOF, I have hereunto set hand and se	n and said Letters Patent and sai o carry out the proposes thereof.	d
Note: An application data sheet (PTO/SB/14 or equivalent inventive entity, must accompany this form. Use this form		

Page 1 of 4

NPO#REA-P1071-USA:0 CUST#108A-259US

F#NPO-P0002E-US1201 DSB0-108U036077

# Docket No REAP1071USA

LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor:

Chien-Cheng Liu

Date:

2020/5/14

signature: Chien cheny Lin

Page

F#NPO-P0002E-US1201 DSB0-108U036077

# COMBINE DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT

#### Title of Invention:

# METHOD AND APPARATUS FOR PERFORMING POWER MESH OPTIMIZATION WITH AID OF ADDITIONAL WIRES

•			
As the below named inventor, I here This declaration is directed to:	by declare that:		
☑ The attached application, or			
☐ United States application nu	mber	filed on, c	or
□ PCT international application number		filed on	
The above-identified application was	made or authorized to be made	by me.	
I believe that I am the original invent application.	or or an original joint inventor of	a claimed invention in the	
I hereby acknowledge that any willfu under18 U.S.C. 1001 by fine or impri	I false statement made in this de isonment of not more than five (	claration is punishable 5) years, or both.	
In consideration of the payment by	Realtek Semiconductor C	orp. having a postal addre	ss of
2 Innovation Rd. II, Science P	ark, HsinChu 30076, Taiwa	ın, R.O.C.	
(referred to as "ASSIGNEE" below) to acknowledged, andfor other good an	o I of the sum of One Dollar (\$ 1. d valuable consideration.	00), the receipt of which is here	by
I hereby sell, assign and transfer to A the entire right, title and interest in ar invention as above-identified applica invention by the above application or substitutes, or extensions thereof, ar	nd to any and all improvements w tion and, in and to, all Letters Pa any continuations, continuation	which are disclosed in the tent to be obtained for said in-part, divisions, renewals,	Ξ
I hereby covenant that no assignment entered into which would conflict with	nt, sale, agreement or encumbra n this assignment;	nce has been or will be made or	•
I further covenant that ASSIGNEE wi and documents relating to said inven known and accessible to I and will te related thereto and will promptly exec	tion and said Letters Patent and stify as to the same in any interfe	legal equivalents as may be erence, litigation proceeding	
representatives any and all papers, in maintain, issue and enforce said app equivalents thereof which may be ne IN WITNESS WHEREOF, I have her	lication, said invention and said cessary or desirable to carry out	Letters Patent and said the proposes thereof.	
Note: An application data sheet (PTC inventive entity, must accompany this			

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NPO#REA-P1071-USA:0 CUST#108A-259US F#NPO-P0002E-US1201 DSB0-108U036077

### Docket No REAP1071USA

Inventor: Yun-Chih Chang

Date: 2020/5/14

Signature: 

Date: 2020/5/14

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PATENT REEL: 052681 FRAME: 0270